

DIAMOND COATED WIRE & BANDSAW BLADE

ELECTROPLATED TYPE
SWARMER

ELECTROPLATED BAND SAW

Pressure Gauge

Pressure Drive Bar

Description	Motherwire Diameter	Diamond Grains size	Actual Diameter	Length
Silicon ingot blocking squaring	0.25mm	40-60 μm	350 μm	10km-150km
	0.25mm	30-40 μm	300 μm	10km-150km
Sapphire slicing	0.18mm	30-40 μm	240 μm	10km-150km
Silicon ingot slicing	0.14mm	10-20 μm	160 μm	10km-150km
	0.12mm	10-20 μm	140 μm	10km-150km
	0.12mm	6-12 μm	122 μm	10km-150km

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	MOTHERWIRE DIAMETER	DIAMOND GRAIN SIZE	ACTUAL DIAMETER	LENGTH
SILICON INGOT BLOCKING SQUARING	0.25mm	40-60	350	10km-150km
	0.25mm	30-40	300	10km-150km
SAPPHIRE SLICING	0.18mm	30-40	240	10km-150km
SILICON INGOT SLICING	0.14mm	10-20	160	10km-150km
	0.12mm	10-20	140	10km-150km
	0.12mm	6-12	122	10km-150km 10km-150km